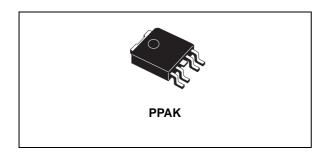


# LD49300

## 3 A very low-dropout voltage regulator

Datasheet - production data



## Features

- Input voltage range:
  - V<sub>I</sub> = 1.4 V to 5.5 V
  - V<sub>BIAS</sub> = 3 V to 6 V
- Stable with ceramic capacitors
- ±1.5% initial tolerance
- Maximum dropout voltage (V<sub>I</sub> V<sub>O</sub>) 400 mV over the operating temperature range
- Adjustable output voltage starting from 0.8 V
- Very fast transient response (up to 10 MHz bandwidth)
- Excellent line and load regulation specifications
- Logic-controlled shutdown option
- Thermal shutdown and current limit protection
- Junction temperature range: 25 °C to 125 °C

## Applications

- Graphics processors
- PC add-in cards
- Microprocessor core voltage supply
- Low voltage digital ICs
- High efficiency linear power supplies
- SMPS post regulators

## Description

The LD49300 is a high-bandwidth, low-dropout, 3.0 A voltage regulator, ideal for powering core voltages of low power microprocessors. The LD49300 implements a dual supply configuration, which guarantees a very low output impedance and a fast transient response. The LD49300 requires a bias input supply and a main input supply, allowing ultra-low input voltages on the main supply rail. The input supply operates from 1.4 V to 5.5 V and bias supply requires between 3 V and 6 V to work properly. The LD49300 offers fixed output voltages from 0.8 V to 1.8 V and adjustable output voltages from 0.8 V. The LD49300 requires a minimum output capacitance for stability, and works optimally with small ceramic capacitors.

Table 1. Device summa	ary
-----------------------	-----

Order codes	Package	Packaging
LD49300PT08R <sup>(1)</sup>	PPAK (tape and reel)	2500 pieces per reel
LD49300PT10R	PPAK (tape and reel)	2500 pieces per reel
LD49300PT12R	PPAK (tape and reel)	2500 pieces per reel

1. Adjustable version.

This is information on a product in full production.

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# **1** Typical application circuits

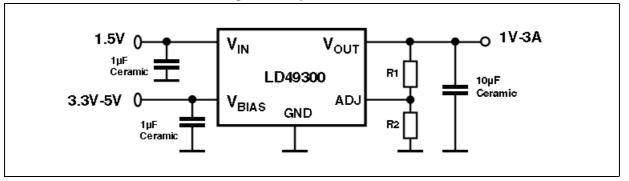
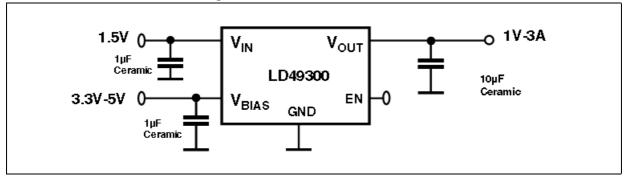


Figure 1. Adjustable version

Figure 2. Fixed version with enable





# 2 Alternative application circuits

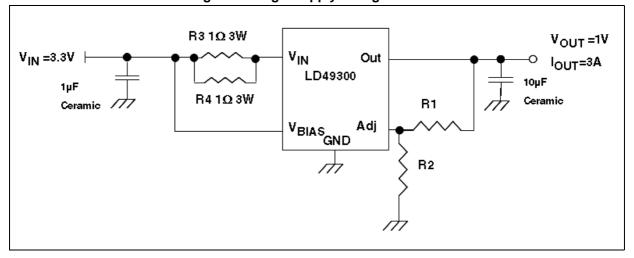
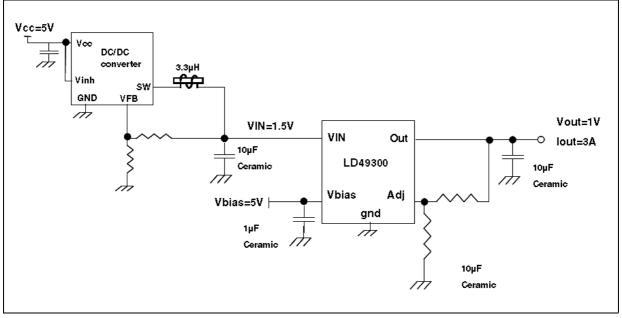


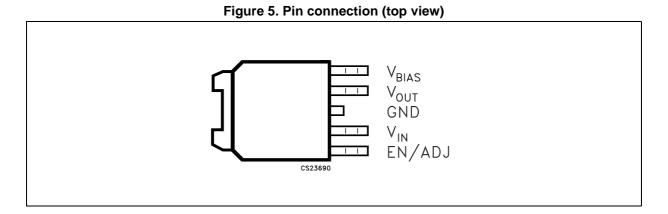
Figure 3. Single supply voltage solution







# 3 Pin configuration



Pin	Symbol	Note	
1	EN	Enable (input): logic high = enable, logic low = shutdown	
	ADJ	Adjustable regulator feedback input connected to resistor voltage divider	
2	V <sub>IN</sub>	Input voltage regulator	
3	GND	Ground (tab is connected to ground)	
4	V <sub>OUT</sub>	Regulator output	
5	V <sub>BIAS</sub>	Input bias voltage powers the circuitry on the regulator except the output power device	



# 4 Diagram

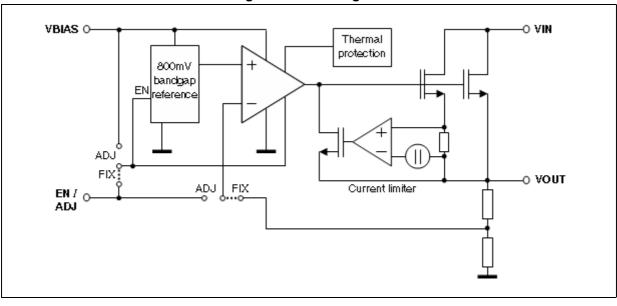


Figure 6. Block diagram



# 5 Maximum ratings

		_	
Symbol	Parameter	Value	Unit
V <sub>IN</sub>	Supply voltage	-0.3 to 7	V
V <sub>OUT</sub>	Output voltage	-0.3 to V <sub>IN</sub> + 0.3 -0.3 to V <sub>BIAS</sub> + 0.3	V
V <sub>BIAS</sub>	Bias supply voltage	-0.3 to 7	V
V <sub>EN</sub> Enable input voltage		-0.3 to 7	V
PD	Power dissipation	Internally limited	
T <sub>STG</sub>	Storage temperature range	-50 to 150	°C

#### Table 3. Absolute maximum ratings

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All values are referred to ground.

#### Table 4. Operating ratings

Symbol	Parameter	Value	Unit
V <sub>IN</sub>	Supply voltage	1.4 to 5.5	V
V <sub>OUT</sub>	Output voltage	0.8 to 4.5	V
V <sub>BIAS</sub>	Bias supply voltage	3 to 6	V
V <sub>EN</sub> Enable input voltage		0 to V <sub>BIAS</sub>	V
TJ	Junction temperature range	- 25 to 125	°C



## 6 Electrical characteristics

 $\begin{array}{l} T_J=-25\ ^\circ C\ to\ 125\ ^\circ C;\ V_{BIAS}=V_O+2.1\ V^{(1)};\ V_I=V_O+1\ V;\ V_{EN}=V_{BIAS}^{(2)};\ I_O=10\ mA;\\ C_I=1\ \mu F;\ C_O=10\ \mu F;\ C_{BIAS}=1\ \mu F;\ unless\ otherwise\ specified.\ Typical\ values\ are\ referred\ to\ T_J=25\ ^\circ C. \end{array}$ 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
		$T_J = 25 \text{ °C}$ , fixed voltage option	fixed voltage option -1.5		1.5		
Vo	Output voltage accuracy	T <sub>J</sub> = -25 °C to 125 °C	-3		3	%	
V <sub>LINE</sub>	Line regulation	$V_{I} = V_{O} + 1 V \text{ to } 5.5 V$	-0.1		0.1	%/V	
V <sub>LOAD</sub>	Load regulation	$I_L = 0 \text{ mA to 3 A}, V_{BIAS} \ge 3 \text{ V}$			1	%	
M		I <sub>L</sub> = 1.5 A			200		
V <sub>DROP</sub>	Dropout voltage (V <sub>I</sub> - V <sub>O</sub> )	I <sub>L</sub> = 3 A			400	mV	
V <sub>DROP</sub>	Dropout voltage (V <sub>BIAS</sub> - V <sub>O</sub> )	$I_L = 3 A^{(1)}$		1.5	2.1	V	
	One of the summer t	$I_L = 0 \text{ mA}$		4	6	mA	
I <sub>GND</sub>	Ground pin current	I <sub>L</sub> = 3 A		4	6		
I <sub>GND_SHD</sub>	Ground pin current in shutdown	$V_{EN} \leq 0.4 \ V^{(2)}$			5	μA	
		$I_L = 0 \text{ mA}$		3	5	– mA	
I <sub>VBIAS</sub>	Current through V <sub>BIAS</sub>	I <sub>L</sub> = 3 A		3	5		
١ <sub>L</sub>	Current limit	V <sub>O</sub> = 0 V	4.5			Α	
Enable inp	ut <sup>(2)</sup>		•		•		
N	Enable input threshold (fixed	Regulator enable	1.4				
V <sub>EN</sub>	voltage only)	Regulator shutdown		0.4		V	
I <sub>EN</sub>	Enable pin input current			0.1	1	μA	
Reference			•		•	1	
V <sub>REF</sub>		T <sub>J</sub> = 25 °C	0.788	0.8	0.812	V	
	Reference voltage	T <sub>J</sub> = -25 °C to 125 °C	0.776	0.8	0.824	V	
SVR	Supply voltage rejection	$V_{I} = 2.5 V \pm 0.5 V, V_{O} = 1 V$ F = 120 Hz, V <sub>BIAS</sub> = 3.3 V		68		dB	

1. For  $V_O \leq$  1 V,  $V_{BIAS}$  dropout specification is not applied due to 3 V minimum  $V_{BIAS}$  input.

2. Fixed output voltage version only.



# 7 Typical characteristics

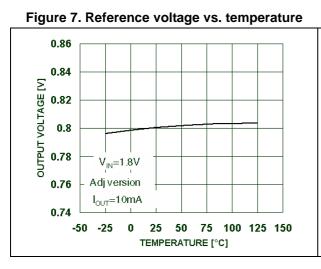


Figure 9. Load regulation vs. temperature

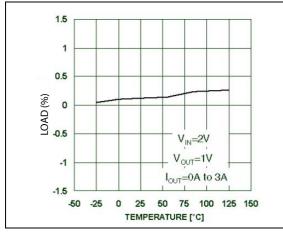
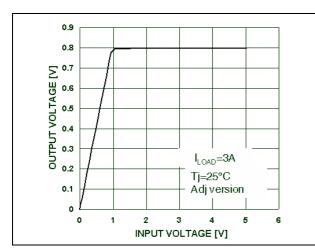
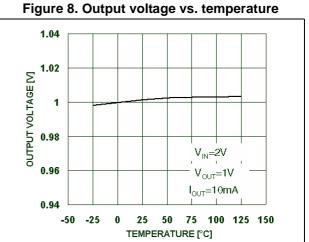


Figure 11. Output voltage vs. input voltage







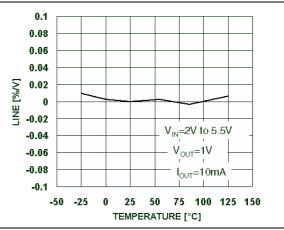
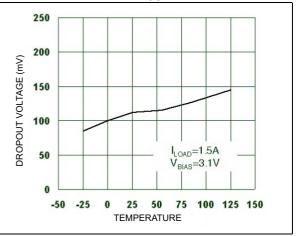


Figure 12. Dropout voltage (V<sub>IN</sub>-V<sub>OUT</sub>) vs. temperature (I<sub>OUT</sub> = 1.5 A)





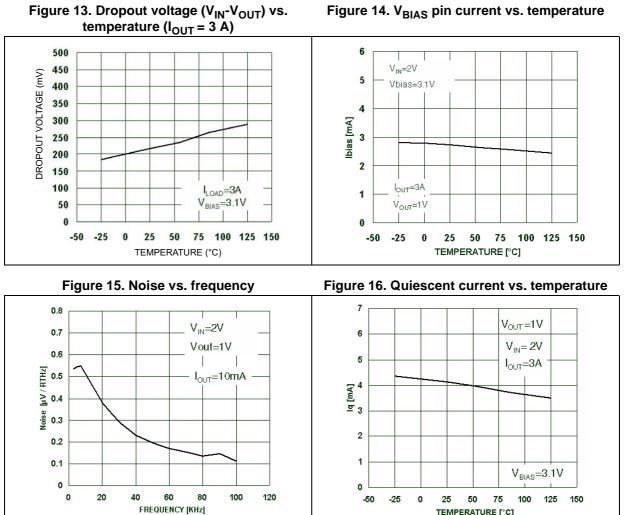


Figure 17. Supply voltage rejection vs. output Figure 18. Stable region vs. C<sub>OUT</sub> and high ESR current

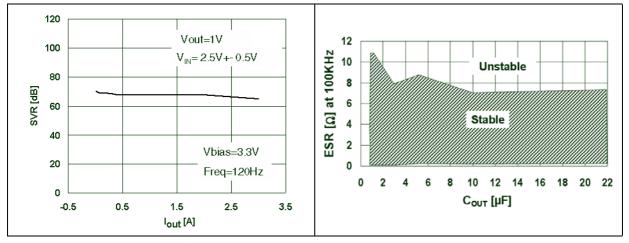


Figure 14. V<sub>BIAS</sub> pin current vs. temperature

TEMPERATURE [°C]





VIN

VBIAS

VOUT

Ch3 500mY

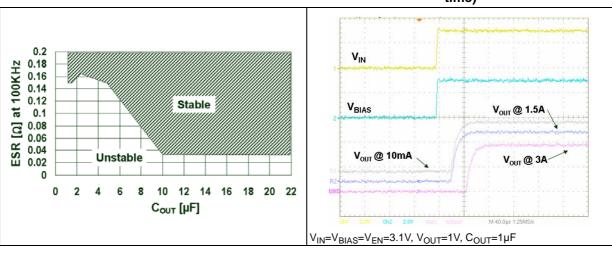


Figure 19. Stable region vs.  $\mathrm{C}_{\mathrm{OUT}}$  and low ESR

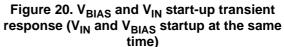
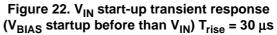
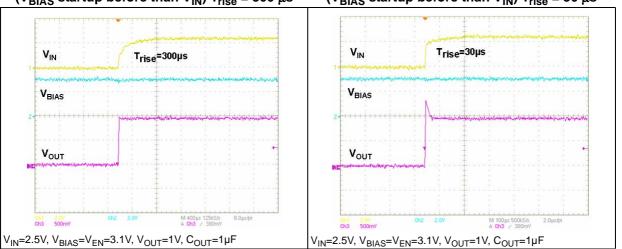
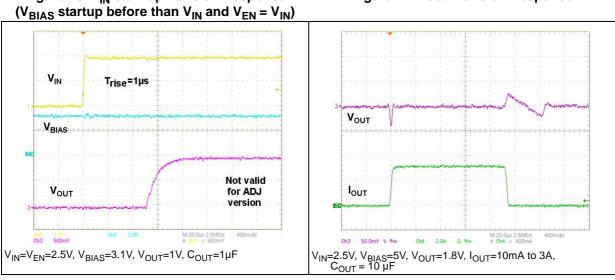


Figure 21.  $V_{IN}$  start-up transient response ( $V_{BIAS}$  startup before than  $V_{IN}$ )  $T_{rise} = 300 \ \mu s$ 

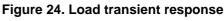








# Figure 23. $V_{IN}$ start-up transient response ( $V_{BIAS}$ startup before than $V_{IN}$ and $V_{EN} = V_{IN}$ )





## 8 Application hints

The LD49300 is a low-dropout linear regulator, designed for high-current applications requiring a fast transient response. The LD49150 has separate input and bias voltage ports, in order to reduce dropout voltage. Thanks to the LD49300, a minimum quantity of external components is required.

## 8.1 Input supply voltage (V<sub>IN</sub>)

 $V_{\rm IN}$  provides the LD49300 with power input current. The minimum input voltage can be as low as 1.4 V, allowing conversion from very low voltage supplies to achieve low output voltage levels and low power dissipation.

## 8.2 Bias supply voltage (V<sub>BIAS</sub>)

The LD49300 control circuitry is supplied by V<sub>BIAS</sub> pin, which requires a very low bias current (3 mA typ.) even at the maximum output current level (3 A). A bypass capacitor on V<sub>BIAS</sub> pin improves the LD49300 performance during line and load transient. The small ceramic capacitor from V<sub>BIAS</sub> to ground reduces high frequency noise that could be injected into the control circuitry. In typical applications, one ceramic chip capacitor of 1  $\mu$ F may be used. V<sub>BIAS</sub> input voltage has to be 2.1 V above the output voltage, with a minimum V<sub>BIAS</sub> input voltage of 3 V.

#### 8.3 External capacitors

To assure regulator stability, input and output capacitors are required as shown in the typical application circuit.

## 8.4 Output capacitor

The LD49300 requires a minimum output capacitance to maintain stability. At least 1  $\mu$ F ceramic chip capacitor is required. However, specific capacitor selection assures the transient response. 1  $\mu$ F ceramic chip capacitor satisfies most applications but 10  $\mu$ F capacitor guarantees a better transient performance. In applications where V<sub>IN</sub> level is close to the maximum operating voltage (V<sub>IN</sub> > 4 V), a 10  $\mu$ F minimum output capacitor avoids the overvoltage stress on the input/output power pins during short-circuit conditions due to parasitic inductive effect. The output capacitor has to be as closer as possible to the LD49300 output pin. ESR output capacitor (equivalent series resistance) has to be within the stable region as shown in Section 7: Typical characteristics. Both ceramic and tantalum capacitors are suitable.

## 8.5 Minimum load current

The LD49300 does not require a minimum load to maintain the output voltage regulation.



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#### 8.6 **Power sequencing recommendations**

To assure the correct biasing and settling of the regulator internal circuitry during the startup phase, as well as to avoid overvoltage spikes on the output, the correct power sequencing has to be provided.

As general rule, V<sub>IN</sub> and V<sub>EN</sub> signal timings should be chosen properly, so that they are applied to the device after V<sub>BIAS</sub> voltage has already been settled on its minimum operative value (see Section 8.2: Bias supply voltage (VBIAS)). This can be achieved, for instance, by avoiding too slow V<sub>BIAS</sub> rising edges (T<sub>r</sub> > 10 ms).

Provided that the above condition is satisfied, when fast V<sub>IN</sub> transient input (T<sub>r</sub> < 100  $\mu$ s) is present, a smooth startup, with limited overvoltage on the output, can be achieved simultaneously by V<sub>IN</sub> and V<sub>BIAS</sub> voltage (refer to *Figure 20*, *Figure 21* and *Figure 22*).

In the fixed voltage version, overvoltage spikes can be reduced during very fast startup ( $T_r << 100 \ \mu$ s) by pulling V<sub>EN</sub> pin up to V<sub>IN</sub> voltage (see *Figure 23*).

## 8.7 Power dissipation/heatsinking

In relation to the maximum power dissipation and maximum ambient temperature of the application, a heatsink may be required. Junction temperature has to be within the specified range under operating conditions. The total power dissipation of the device is given by:

#### **Equation 1**

 $P_{D} = V_{IN} \times I_{IN} + V_{BIAS} \times I_{BIAS} - V_{OUT} \times I_{OUT}$ 

where:

- V<sub>IN</sub> = input supply voltage
- V<sub>BIAS</sub> = bias supply voltage
- V<sub>OUT</sub> = output voltage
- I<sub>OUT</sub> = load current

The required  $\theta_{SA}$  thermal resistance for the heatsink is given by the following formula:

#### Equation 2

 $\theta_{SA} = (T_J - T_A/P_D) - (\theta_{JC} + \theta_{CS})$ 

 $T_{Rmax}$ , the maximum allowed temperature rise depends on  $T_{Amax}$ , the maximum ambient temperature of the application, and  $T_{Jmax}$ , the maximum allowable junction temperature:

#### Equation 3

 $T_{Rmax} = T_{Jmax} - T_{Amax}$ 

The maximum allowable value for junction-to-ambient thermal resistance,  $\theta_{\text{JA}}$  , can be calculated as follows:

#### **Equation 4**

 $\theta_{JAmax} = T_{Rmax} / P_D$ For PPAK package only.

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The thermal resistance depends on the amount of copper area or heatsink, and on the air flow. If  $\theta_{JA}$  maximum allowable value is  $\geq 100$  °C/W for PPAK package, no heatsink is needed since the package can dissipate enough heat to satisfy these requirements. If the value for allowable  $\theta_{JA}$  falls below these limits, a heatsink is required as described below.

## 8.8 PPAK package heatsinking

PPAK package uses the copper plane on the PCB as a heatsink. The tab of this package is soldered to the copper plane for heatsinking. The PCB ground plane can be used as a heatsink. This area can be the inner GND layer of a multi-layer PCB, or, in a dual-layer PCB, it can be the unbroken GND area on the bottom layer thermally connected to the tab through-via holes.

Figure 25 shows  $\theta_{JA}$  curve for PPAK package for different copper area sizes, using a typical PCB: thickness 1/16 G10 FR4.

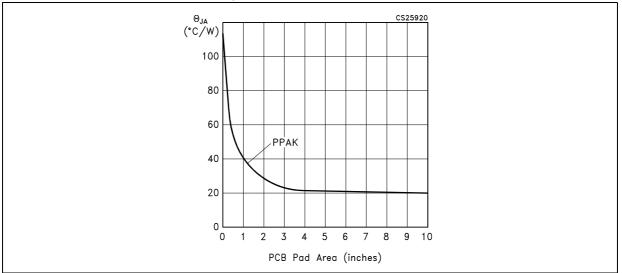


Figure 25.  $\theta_{JA}$  vs. copper area for PPAK package

## 8.9 Adjustable regulator design

The LD49300 adjustable version allows the output voltage to be fixed anywhere between 0.8 V and 4.5 V using two resistors as shown in the typical application circuit. For example, to fix R1 resistor value between V<sub>OUT</sub> and ADJ pin, the resistor value between ADJ and GND (R2) is calculated as follows:

#### **Equation 5**

 $R2 = R1 [0.8 / (V_{OUT} - 0.8)]$ 

where  $V_{\mbox{\scriptsize OUT}}$  is the desired output voltage.

R1 values should be lower than 10 k $\Omega$  to obtain a better load transient performance. Higher values up to 100 k $\Omega$  are suitable.



#### 8.10 Enable

The LD49300 fixed output voltage version features an active high enable input (EN) that allows the on-off control of the regulator. EN input threshold is guaranteed between 0.4 V and 1.4 V. The regulator is in shutdown mode when  $V_{EN} < 0.4$  V and it is in operating mode ( $V_{OUT}$  activated) when  $V_{EN} > 1.4$  V. If it is not in use, EN pin has to be tied directly to  $V_{IN}$  to keep the regulator continuously activated. EN pin has not to be left with high impedance.



# 9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



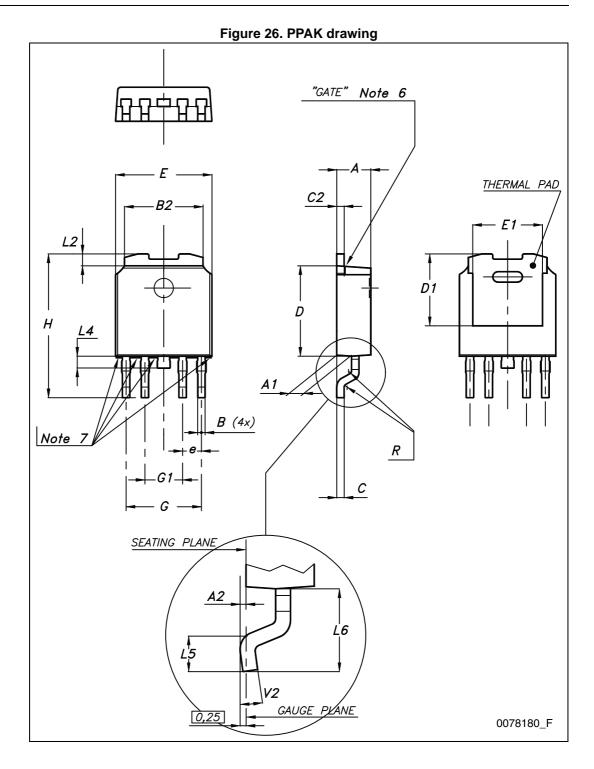
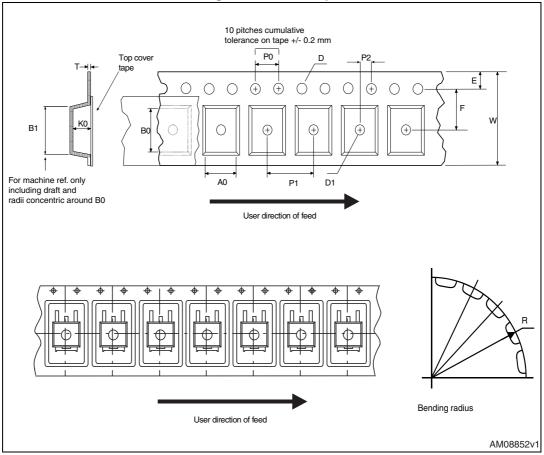


Table 6. PPAK mechanical data			
Dim.		mm	
Dim.	Min.	Тур.	Max.
А	2.2		2.4
A1	0.9		1.1
A2	0.03		0.23
В	0.4		0.6
B2	5.2		5.4
С	0.45		0.6
C2	0.48		0.6
D	6		6.2
D1		5.1	
E	6.4		6.6
E1		4.7	
е		1.27	
G	4.9		5.25
G1	2.38		2.7
Н	9.35		10.1
L2		0.8	1
L4	0.6		1
L5	1		
L6		2.8	
R		0.20	
V2	0°		8°

Table 6. PPAK mechanical data



# 10 Packaging mechanical data







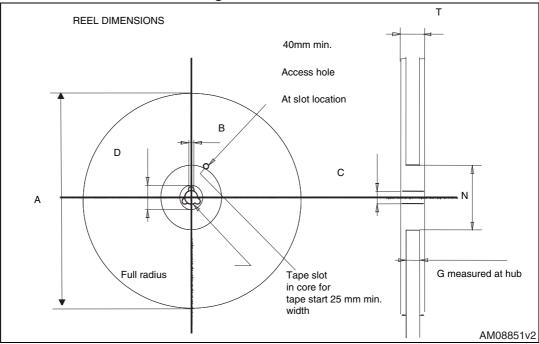


Figure 28. PPAK reel

	Таре			Reel		
		mm	Dim	mm		
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	А		330	
B0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
Е	1.65	1.85	Ν	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1		Base qty.	2500	
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

#### Table 7. PPAK tape and reel mechanical data



# 11 Revision history

Date	Revision	Changes
20-Nov-2006	1	Initial release.
01-Dec-2006	2	Add note in cover page.
29-Jun-2010	3	Modified Section 8.6: Power sequencing recommendations on page 14.
26-May-2014	4	Changed the part numbers LD49300xx08, LD49300xx10 and LD49300xx12 to LD49300. Changed the title. Updated the description in cover page and <i>Section 9: Package mechanical data</i> . Added <i>Section 10: Packaging mechanical data</i> . Minor text changes.

#### Table 8. Document revision history



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